

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	4159048
<b>Application Number:</b>	10582883
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	8717
<b>Title of Invention:</b>	Thermoplastic resin composition, material for substrate and film for substrate
<b>First Named Inventor/Applicant Name:</b>	Koichi Shibayama
<b>Customer Number:</b>	74384
<b>Filer:</b>	Lee Cheng/Maki Huffman
<b>Filer Authorized By:</b>	Lee Cheng
<b>Attorney Docket Number:</b>	MIY-0214
<b>Receipt Date:</b>	22-OCT-2008
<b>Filing Date:</b>	14-JUN-2006
<b>Time Stamp:</b>	16:47:49
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	MIY-0214_IDS.pdf	117142 010df1f6102a9f0eb18487ec1cd6cf75c2ded4b9	no	2

### Warnings:

### Information:

2	Information Disclosure Statement (IDS) Filed (SB/08)	MIY-0214_PTO-1449.pdf	38276 46ec8620bef4269f943f7938d9c4c7fb17ed d699	no	1
<b>Warnings:</b>					
<b>Information:</b>					
This is not an USPTO supplied IDS fillable form					
3	Foreign Reference	MIY-0214_CN_1070210_C.pdf	931142 3c8458abedc5645e84f7162d643636300f8f 6984	no	15
<b>Warnings:</b>					
<b>Information:</b>					
4	Foreign Reference	MIY-0214_JP_2003-026939.pdf	4291940 31889c50519bf8dd035ecd36a559b48f42 bf644	no	46
<b>Warnings:</b>					
<b>Information:</b>					
5	NPL Documents	MIY-0214_China_Office_Action .pdf	488863 7d9a067c05deb867471aa6d28673956fd10 0f22e	no	5
<b>Warnings:</b>					
<b>Information:</b>					
<b>Total Files Size (in bytes):</b>			5867363		
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